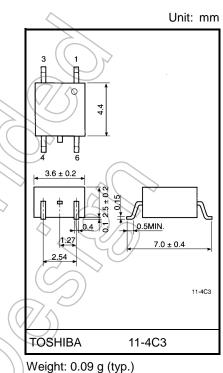
TOSHIBA

TOSHIBA Photocoupler IRED & Photo-Triac

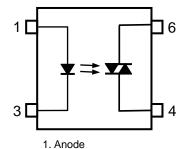
TLP160G

Triac Drive Programmable Controllers AC-Output Module Solid State Relay The TOSHIBA mini flat coupler TLP160G is a small outline coupler, suitable for surface mount assembly. The TLP160G consists of a photo triac, optically coupled to an infrared $3.6 \pm 0.$ emitting diode. Peak off-state voltage: 400 V (min) Trigger LED current: 10 mA (max) .27 On-state current: 70 mA (max) Isolation voltage: 2500 Vrms (min) UL-recognized: UL 1577, File No.E67349 cUL-recognized: CSA Component Acceptance Service No.5A

- cUL-recognized: CSA Component Acceptance Service File No.E67349
- VDE-approved: EN 60747-5-5 (Note 1)
 - Note 1: When a VDE approved type is needed, please designate the **Option(V4)**.



Pin Configurations (top view)



Anode Cathode

- 4. Triac Terminal
- 6. Triac Terminal

Trigger LED Current

| - | | | |
|----------------------------|-----------------|--------------------------------|------------------------------|
| Classification (Note 1) | // | Current (mA) Ta=25°C Max | Marking of Classification |
| | | Max | |
| (IFT5) | - \\ | 5.0 | T5 |
| (IFT7) | \sim – \sim | 7.0 | T5, T7 |
| Standard | | 10.0 | T5, T7, blank |
| | | | |

Note 1: (IFT5); TLP160G (IFT5) Note: Application type name for certification test, please use standard product type name, i.e. TLP160G(IFT5): TLP160G

Absolute Maximum Ratings (Ta = 25°C)

| Characteristics | | Symbol | Rating | Unit | | |
|-----------------------------------|--|------------------|----------------------|-------|---------|-------------------------------|
| Forward current | | lF | 50 | mA | | |
| | Forward current derating (Ta ≥ 53°C) | | ΔI _F / °C | -0.7 | mA / °C | |
| | Peak forward current (100µs pulse, 100 pps) | | I _{FP} | 1 | A | |
| LED | Reverse voltage | | VR | 5 | v Ç | |
| | Diode power dissipation | | PD | 100 | mW | \mathcal{A} |
| | Diode power dissipation derating (Ta ≥ 53°C) | | $\Delta P_D /°C$ | -1.4 | mW/°C | |
| | Junction temperature | | Tj | 125 | °C |) |
| | Off- state output terminal voltage | | V _{DRM} | 400 | × | |
| | On-state RMS current | Ta=25°C | IT(RMS) | 70 | mA | |
| | | Ta=70°C | | 40 | | |
| - | On-state current derating (Ta ≥ 25°C) | | ΔIT / °C | -0.67 | mA / °C | |
| Detector | Peak on-state current (100µs pulse, 120 pps) | | ITP | (/2 | A | $\langle \mathcal{O} \rangle$ |
| Det | Peak non-repetitive surge current (Pw=10ms) | | Ітѕм | 1.2 | A | |
| | Output power dissipation | | Po | 200 | m₩ | |
| | Output power dissipation derating (Ta ≥ 25°C) | | ΔP₀/°C | -2.0 | m₩./°C |) |
| | Junction temperature | | TT I | 115 | ~0 | |
| Storage temperature range | | Tstg | -55 to 125 | °¢ | | |
| Operating temperature range | | Topr | -40 to 100 | °C | | |
| Lead soldering temperature (10 s) | | T _{sol} | 260 |) °C | | |
| Isolatic | Isolation voltage (AC, 60 s, R.H. ≤ 60 %) (Note 1) | |)) BVs | 2500 | Vrms | |

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Recommended Operating Conditions

| Characteristics | Symbol | Min | Тур. | Max | Unit |
|-----------------------|------------------|-----|------|-----|------|
| Supply voltage | V _{AC} | _ | _ | 120 | Vac |
| Forward current | lF | 15 | 20 | 25 | mA |
| Peak on-state current | I _{TP} | _ | _ | 1 | А |
| Operating temperature | T _{opr} | -25 | | 85 | °C |

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Note 1: Device considered a two terminal device: Pins 1 and 3 shorted together and pins 4 and 6 shorted together.

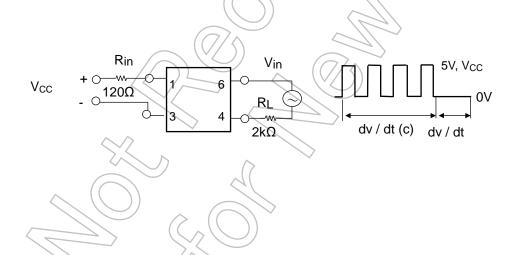
Electrical Characteristics (Ta = 25°C)

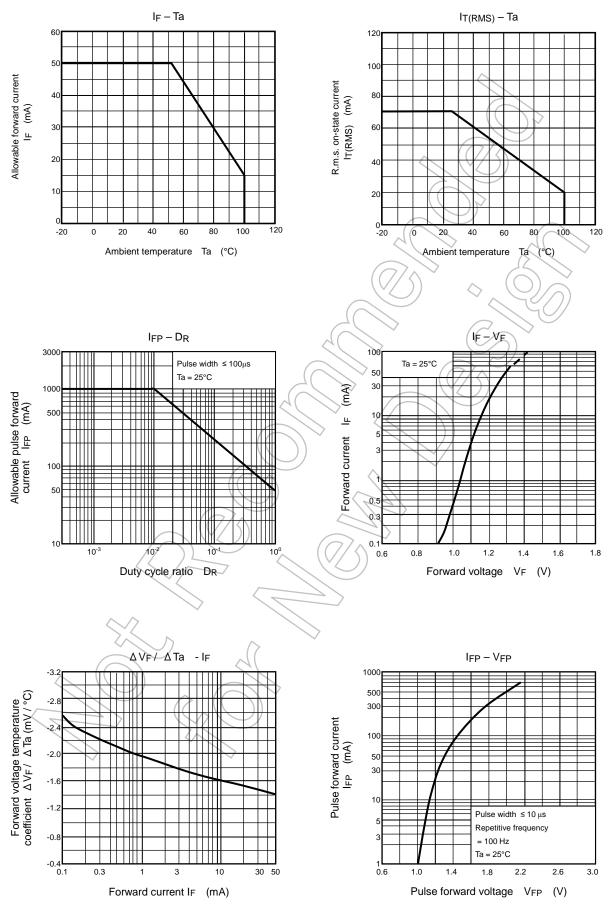
| | Characteristics | Symbol | Test Condition | Min | Тур. | Max | Unit |
|----------|---|------------|---|---------------------------|------|------|--------|
| | Forward voltage | VF | I _F = 10 mA | 1.0 | 1.15 | 1.3 | V |
| LED | Reverse current | IR | V _R = 5 V | _ | _ | 10 | μA |
| | Capacitance | CT | VF = 0 V, f = 1 MHz | / | 30 | _ | pF |
| Detector | Peak off-state current | IDRM | VDRM = 400 V | $\langle \langle \rangle$ | 10 | 1000 | nA |
| | Peak on-state voltage | Vтм | I _{TM} = 70 mA | \mathbb{C} | 1.7 | 2.8 | V |
| | Holding current | lΗ | 6 | $\widetilde{\mathcal{A}}$ | 0.6 | _ | mA |
| | Critical rate of rise of off-state voltage | dv / dt | Vin = 120 Vrms, Ta = 85 °C (Fig.1) | 200 | 500 | | V / µs |
| | Critical rate of rise of commutating voltage | dv / dt(c) | I _T = 15 mA, V _{in} = 30 Vrms (Fig.1) | _ | 0.2 | | V / µs |

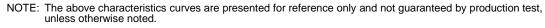
Coupled Electrical Characteristics (Ta = 25°C)

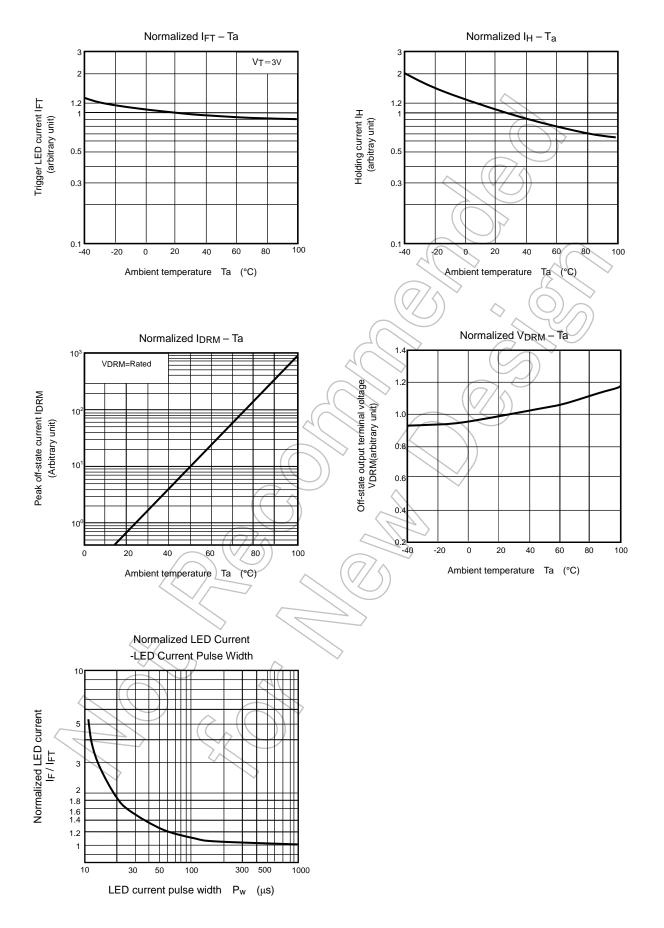
| | | | / | | 2 | |
|-----------------------------|--------|--|--------------------|------------------|-----|------|
| Characteristics | Symbol | Test Condition | Min | тур | Max | Unit |
| Trigger LED current | IFT | V _T = 3V | | 5 | 10 | mA |
| Capacitance input to output | Cs | Vs = 0 V, f = 1 MHz | (\overline{a}) | 0.8 | _ | pF |
| Isolation resistance | Rs | Vs = 500 V, R.H. ≤ 60 % | 1×10 ¹² | 10 ¹⁴ | _ | Ω |
| Isolation voltage | BVs | AC, 60 s | 2500 | — | _ | Vrms |
| Turn-on time | ton | $V_D = 6 \rightarrow 4 V, R_L = 100 \Omega$ IF= Rated IFT×1.5 | 2_ | 30 | 100 | μs |

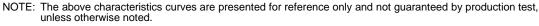
Fig.1: dv / dt Test Circuit











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